SONY

CXB1818Q

Laser Diode Driver

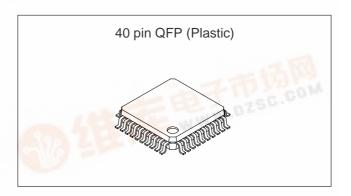
Description

The CXB1818Q is a high-speed monolithic Laser Diode Driver/Current Switch with ECL/PECL input level. Open collector outputs are provided at the output pins (Q, QBX) and have the capacity of driving modulation current of 50mAp-p at a maximum data rate of 622Mbps. Along with the modulation current generator there is the laser diode bias current generator which has capacity of sourcing up to 60mA (Bias). The laser diode bias current can be controlled by either a voltage or current into the bias adjust pin (BiasAdj) and the bias set pin (SBias), depending on how these pins are configured. Control of the bias current is achieved through the APC (Automatic Power Control) circuit. In order to avoid having a large current go through the laser diode, this IC also provides an Activity detector function for laser protection. The Activity detector circuit detects data edge transitions and if no data transition occurs after a certain period, then both the modulation and bias currents are shutdown. The bias currents are shut it down by in order to pull down the output voltage of APC OP.Amp.

When the automatic shutdown is conducted, it is possible to select whether the laser diode alarm output is activated or not. Additionally, this IC has the DFF for the input signal correction and the internal Duty Cycle correction circuit that can control the falling edge of the input pulse up to a maximum of 1.0ns(Min.).

Features

- Maximum data rate (NRZ): 622Mbps
- · Alarm and Shutdown function
- DFF for input signal correction
- Input signal Duty cycle correction
- Automatic Power Control (APC) for bias current
- Activity detector function for laser protection
- Alarm signal mask function during shutdown
- Differential PECL inputs or AC coupled inputs



Applications

SONET/SDH: 622MbpsFibre channel: 531Mbps

Absolute Maximum Ratings

Absolute Maximu	illi Katiligs		
 Supply voltage 	Vcc – Vee	-0.3 to +6.0	V
 Input voltage 	VIN	VEE to VCC	V
• Differential input	voltage		
	VD — VDB	0 to 2.5	V
Bias output curre	ent	0 to 80	mΑ
SBias input/output	ut current	0 to 5	mA
• Bias control curre	ent		
	IBset (Ibiasad	j) 0 to 5	mA
 Bbias control vol 	tage		
	VBset (Vbiasa	ndj) 0 to 3	V
Modulation output	ut current	70	mA
 Modulation adjust 	st current		
	IQset (Idrvadj)	0 to 15	mA
Storage tempera	ture		
	Tstg	-65 to +150	°C

Recommended Operating Conditions

DC supply voltage

Vcc - Vee 3.14 to 3.46 V

Operating ambient temperature

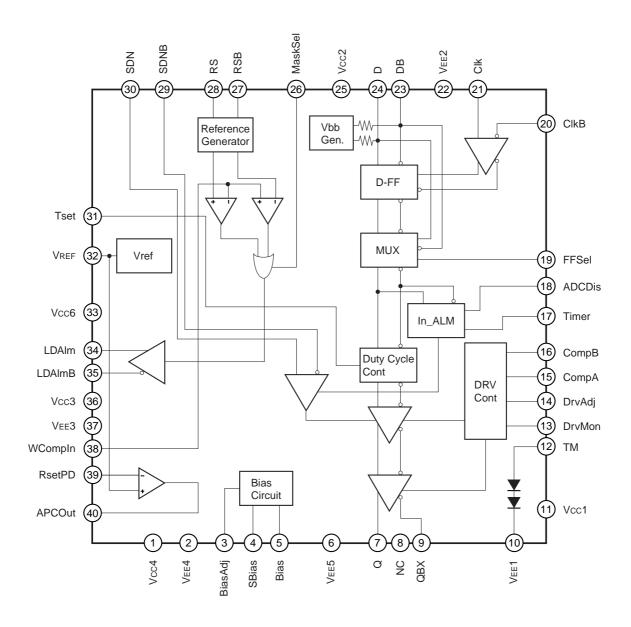
Ta -40 to +85 °C

Structure

Bipolar silicon monolithic IC

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Block Diagram and Pin Configuration



Pin Description

Pin	Symbol	Typical pin	voltage [V]	Equivalent circuit	Description
No.	Symbol	DC	AC	Equivalent circuit	Description
1	Vcc4	3.3			Positive power supply for APC circuit.
2	VEE4	0			Negative power supply for APC circuit.
3	BiasAdj	1.5 to 0		Vcc 4 5	Bias current setting.
4	SBias	0mA to 2.5mA		3 260 10pF 30	Bias current setting or monitor.
5	Bias	0mA to 60mA		VEE	Bias current output. Open collector output.
6	VEE5	0			Negative power supply for bias circuit.
7	Q	1.3 to 3.3	6mA to 30mA*1 6mA to 50mA*2	7 9	Modulation current output. Open collector output.
9	QBX	1.3 to 3.3	6mA to 30mA*1 6mA to 50mA*2	Current Source	Complementary current output. Q and QBX are not symmetrical output. Use Q output for laser diode.
8	NC	_	_		No connected.
10	VEE1	0			Negative power supply for driver circuit.
11	Vcc1	3.3			Positive power supply for driver circuit.
12	ТМ	1.5		12 VEE 10	Chip temperature monitor.
13	DrvMon		0mA to 1.4mA	Vcc Rmon	Modulation current (IQ) monitor. IQ is monitored by connecting a resistor (Rmon) to this pin.
14	DrvAdj	0mA to 9mA		22.5 ₹150 ₹ ★	Modulation current (IQ) setting.

^{*1} Ta = -40 to 0° C

^{*2} Ta = 0 to +85°C

Pin No.	Symbol	Typical pin	voltage [V]	Equivalent circuit	Description
15	CompA			180pF = 15 180pF = 15 16	Modulation current driver compensation. Normally, connects
16	CompB			VEE 10k	180pF capacitor between CompA and CompB pins.
17	Timer			Vcc = Ctimer 100 W 2.4k 10pF 200μA	Capacitor connection for activity detector (IN_ALM) operation. This pin sets the period of inactive time for activity detector. Inactive time is controlled by connecting a capacitor to this pin.
18	ADCDis	VEE to Vcc (open)		3.8k \$3.8k \$3.8k \$3.8k \$35k \$35k \$35k \$35k \$35k \$35k \$35k \$35	Activity detector circuit control. High (connected to Vcc or open): Activity detector is disable. Low (connected to VEE): Activity detector is enable.
19	FFSel	VEE or open		Vcc	Input data D-FF selection control. High (open): FF not used (Through mode) Low (connect to VEE): FF used (FF mode)

Pin No.	Symbol	Typical pin	voltage [V]	Equivalent circuit	Description
20	ClkB		1.6 to 2.4	Vcc \$550 \$550 20 21 200 400μA	Differential PECL clock input.
22	VEE2	0		25	Negative power supply for data input circuit.
23	DB		1.6 to 2.4	24 200 10k	Differential PECL data input.
24	D		1.6 to 2.4	1mA 10k 300μA 1	
25	Vcc2	3.3		(22) 300µA	Positive power supply for data input circuit.
26	MaskSel	VEE or open		Vcc \$9k \$4.5k\$4.5k 26	Alarm signal control for optical power output forced shutdown. High (open): Alarm signal is High for shutdown. Low (connect to VEE): Alarm signal stays Low for shutdown.
27	RSB	0.5		Vcc 100μA ≷2.5k	Window comparator top/bottom threshold voltage for LD_ALARM. The alarm (fault) assert voltage can be set by
28	RS	2.0		₹15k ₹5k	the external resistor. Default voltages are RS equal to 2.0V and RSB equal to 0.5V. (Option)

Pin	Cumbal	Typical pin	voltage [V]	Carrier la est ainscrit	Description
No.	Symbol	DC	AC	Equivalent circuit	Description
29	SDNB		0 to 3.3	Усс 300 300 300 300 300 300 300 3	Complementary TTL input to disable the output current. (Shutdown input) When left open, High.
31	Tset			Vcc 2.4k \$ 2.4k 20pF Rset \$ 31 - 5	Output duty cycle control. This pin controls the falling edge of the input High pulse. Variable delay limit of that is from 0 to 1.0ns. Duty cycle is controlled by connecting a resistor value between Vcc and this pin.
32	VREF	1.7		VCC 300 ₹ 300 200 W 2.4k ₹ 9.1k 1.9mA	Temperature compensated reference voltage for APC. Approximately 1.7V (Constant for VEE reference)
33	Vcc6	3.3			Positive power supply for alarm output circuit.
34	LDAIm		0.2 to 3.0	Vcc 34 34 34	Activates when the fault is detected in the laser monitor diode
35	LDAImB		0.2 to 3.0	VEE 35	circuit. (Pseudo LVTTL output)

Pin	Symbol	Typical pin	voltage [V]	Equivalent circuit	Description
No.	Symbol	DC	AC	Equivalent circuit	Description
36	Vcc3	3.3			Positive power supply for signal detection circuit.
37	VEE3	0			Negative power supply for signal detection circuit.
38	WCompln			VCC 550 \$550 RS 200 RSB 200 RSB 200	APC alarm signal control.
39	RsetPD			300 \$ \$300 39 W 1.8mA	Monitor PD connection.
40	APCOut			40 VEE \$500	APC operational amplifier output. This signal controls the bias adjust pins. (BiasAdj and SBias)

Electrical Characteristics

DC Electrical Characteristics

 $(Vcc = 3.14 \text{ to } 3.46V, Vee = 0V, Ta = -40 \text{ to } +85^{\circ}C)$

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
DC supply voltage	Vdc	Vcc – Vee	3.14	3.3	3.46	V
Supply current	lee	IQ = 0mA, IBIAS = 0mA	-80	-57	_	mA
Modulation output ourrent range	lq1	Ta = -40 to 0°C	6	_	30	A
Modulation output current range	lq2	Ta = 0 to +85°C	6	_	50	mA
Modulation output voltage range	VQ		Vcc – 2	_	Vcc	V
Ratio of IQ vs. IQset	IQ vs IQset		4	6	9	_
Bias output current range	lв		0	_	60	mA
Bias output voltage range	Vв		Vcc – 2	_	Vcc	V
Ratio of IB vs. IBset	IB vs IBset		14	22	28	
ECL input High voltage	VEIH		Vcc - 1.17	_	Vcc - 0.81	
ECL input Low voltage	VEIL		Vcc - 1.84	_	Vcc - 1.48	
SDN, SDNB input High voltage	Vтін		2	_	Vcc	
SDN, SDNB input Low voltage	VTIL		0	_	0.8	V
LDA, LDAB output High voltage	Vтон	lin = −0.4mA	2.4	_	_	
LDA, LDAB output Low voltage	VTOL	lin = 2.0mA	_	_	0.5	
Reference bias voltage for OP Amp	VREF		1.5	1.7	1.9	
Operating current range of VREF	VREFdrv		-500	_	+500	μΑ

AC Electrical Characteristics

 $(Vcc = 3.14 \text{ to } 3.46 \text{V}, Vee = 0 \text{V}, Ta = -40 \text{ to } +85 ^{\circ}\text{C})$

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Maximum data rate	fdmax		622			Mbps
Rise time (20 to 80%)	tr	$I_Q = 20$ mA, $R_L = 25\Omega$		200		no
Fall time (20 to 80%)	tf	$I_Q = 20$ mA, $R_L = 25\Omega$		200		ps
Max. variable High pulse width by duty cycle control	tdelay	Data rate = 622Mbps	1.0			ns
Max. setting time of IN_Alarm	ts_alm		20			
Shutdown time	tsut_off				10	μs
Shutdown recovery time	tsut_on				100	
Maximum set up time	Ts		200			nc
Maximum hold time	Тн		200			ps

DC and AC Electrical Characteristics for OpAmp of APC Circuit

 $(Vcc = 3.14 \text{ to } 3.46 \text{V}, Vee = 0 \text{V}, Ta = -40 \text{ to } +85 ^{\circ}\text{C})$

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Input voltage range	Vin		1.2	_	2.8	V
Output voltage range	Vo		0.6	_	2	V
Input bias current	Ів		_	7	_	μΑ
Input offset voltage	Voff		_	2.5	_	mV
Input offset current	loff		_	0.7	_	μΑ
Input impedance	ZIN		_	12	_	kΩ
Output drive current	lo		-5.0	_	1.0	mA
Through rate	SR		_	1.9	_	V/µs
Open loop gain	Av		_	55	_	dB
Unity gain band width	funit			20	_	MHz

Description of Each Function Block

1. Data Buffer, Clock Buffer

Data Buffer and Clock Buffer are comprised of the data buffer, clock buffer, DFF, MUX and delay generator. ECL/PECL data is input to the data buffer at a maximum data rate of 622Mbps. The input data DFF selection pin (Pin 19 FFSel) can select whether the input data is used in through mode or the signal which is corrected by the clock signal in the DFF is used. When the FFSel is open, the data becomes through mode, when the FFsel is connected VEE, the data becomes DFF mode.

And, this data is input to the delay circuit. The delay circuit adds a delay to the falling edge of the pulse up to a maximum of 1.0ns for the D input signal High pulse (Q output current pulse). The delay is set by an external resistor between the delay set pin (Pin 31 Tset) and Vcc. The relation between the High pulse width and the set resistance (Rset) is shown in Fig. 1.

The Vbb generator provides a reference bias current to the data buffer for AC coupling inputs.

2. Modulation Current Generator

This circuit modulates the laser diode and the modulation current can be set by feeding the current to the modulation current set pin (Pin 14 DrvAdj). The relation between the modulation current (IQ) and the modulation set current (IQset) is shown in Fig. 2. There is also a modulation current monitor pin (Pin 13 DrvMon) that allows the IC user to monitor the modulation current by putting an external fixed resistor between Vcc and DrvMon pins, and the modulation current can be monitored by measuring the voltage of DrvMon pin. The relation between the modulation current (IQ) and the DrvMon current (Idrvmon) is shown in Fig. 7.

3. Laser Diode Bias Current Generator

This circuit is a very large current source capable of sourcing up to 60mA of bias current to the laser diode. The circuit is a 22 to 1 (for current – current setting) current mirror that can be controlled externally two ways. The first method is to short BiasAdj (Pin 3) and SBias (Pin 4) together and inject a control current (IBset) into the two pins. Bias (Pin 5) is connected to the laser diode. Laser diode bias current vs. control current (IBset) characteristics is shown in Fig. 3.

The second method is to tie SBias (Pin 4) to Vcc and tune BiasAdj (Pin 3) with a voltage source. Varying the voltage at the BiasAdj pin will vary the current through the laser diode. Laser diode bias current vs. control voltage characteristics is shown in Fig. 4.

4. APC (Automatic Power Control) Circuit

The APC circuit is comprised of the window comparator, APC OpAmp, and laser diode alarm circuit.

The APC OpAmp is normally configured as an inverting integrator. The inverting input is connected to the photodiode that monitors the optical power output from the laser diode. The photodiode converts the optical power received from the laser diode to a current. The output of the OpAmp then drives the laser diode current bias adjust pin (BiasAdj), and the laser diode current bias set pin (SBias) is shorted to Vcc via a resistor. With the OpAmp configured as an inverting integrator, the OpAmp can tune the laser diode current inversely to the current in the photodiode. That is to say that if a Low current is detected by the photodiode the integrator output goes up causing more bias current to flow through the laser diode. If the photodiode current is High, the output of the OpAmp will go Low causing less bias current to flow through the laser diode.

When the output of the APC OpAmp (Pin 40 APCOut) is connected to the window comparator input pin (Pin 38 WCompln), the function of the window comparator detects the voltage which is outside of the reference voltage range for each comparator (RS, RSB). When this happens, the comparator outputs cause the laser diode alarm output (LDAIm) to go High alerting the system that the laser diode current is in the outside of the range.

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The laser diode alarm output state can be controlled by the alarm signal control pin (Pin 26 MaskSel) for the optical power output forced shutdown. When the automatic shutdown is conducted and MaskSel pin is left open, the laser diode alarm output goes High. The laser diode alarm output is kept Low (disable) by connecting MaskSel pin to VEE.

5. Shutdown and Input Alarm Circuits

These circuits disable both the modulation current and the bias current under various conditions. The function block diagram for all of the shutdown mechanisms for the circuit is shown in Fig. 5.

The Shutdown circuit has complementary TTL input to disable the output current. Shown below is the desired truth table for the shutdown function.

SDN	SDNB	Output current
Low	Low	Off
Low	High	On
High	Low	Off
High	High	Off

The Activity detector (In_ALM) circuit is designed to detect the input data edge transition. If there is no input data transition over a certain period determined by the user (Tact), the Shutdown circuit is enabled, causing the modulation current and bias current to be shutdown. The Inactive time (Tact) is set by the external capacitor value between Timer (Pin 17) and Vcc. The relation between the Inactive time and Ctimer is shown in Fig.6.

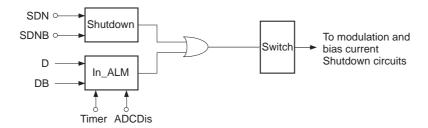


Fig.5. Shutdown and In_ALM Functional Block Diagram

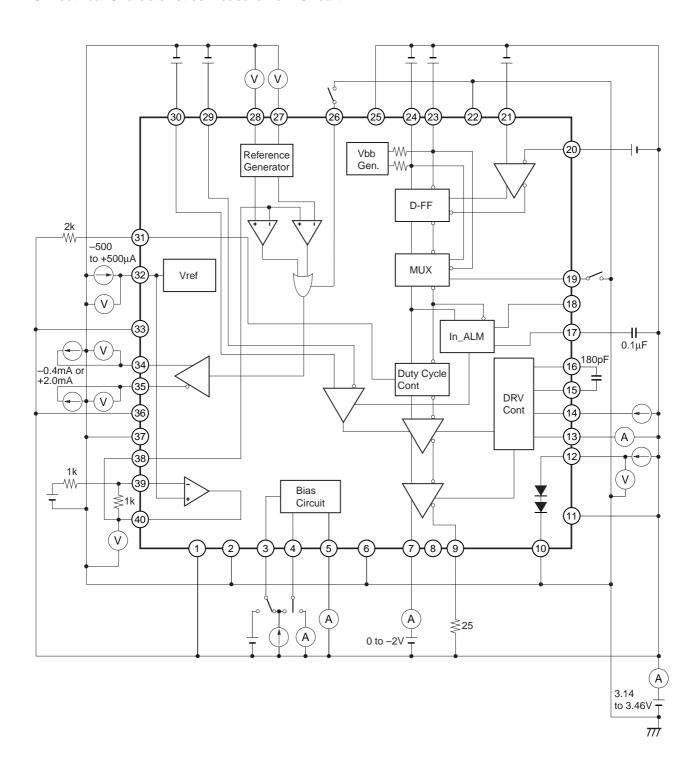
6. Others

Pay attention to handling this IC because its electrostatic discharge strength is weak.

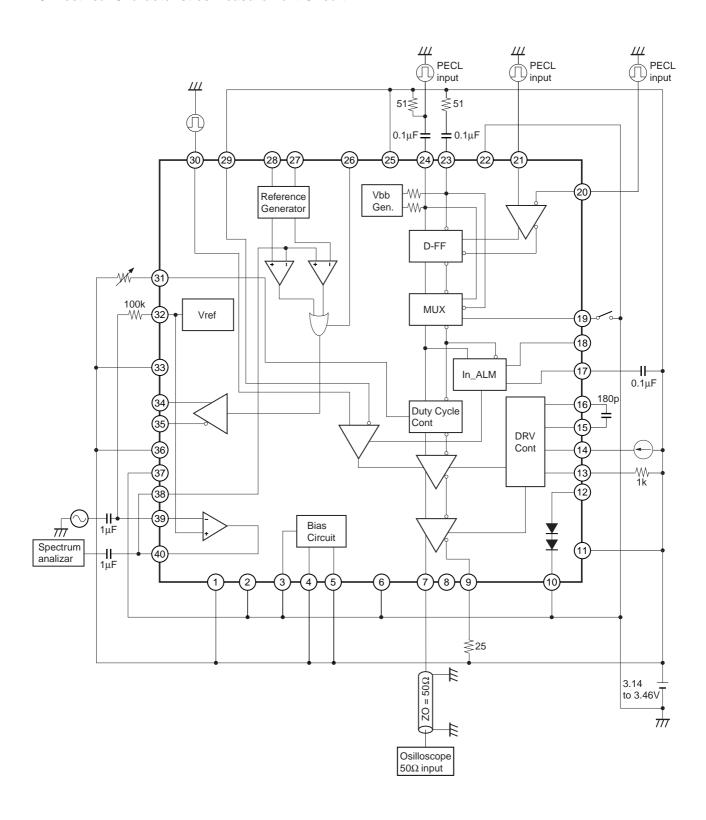
The Tset pin (Pin 31) should be connected to Vcc through a resistor.

Do not leave this pin open or connect to Vcc directly.

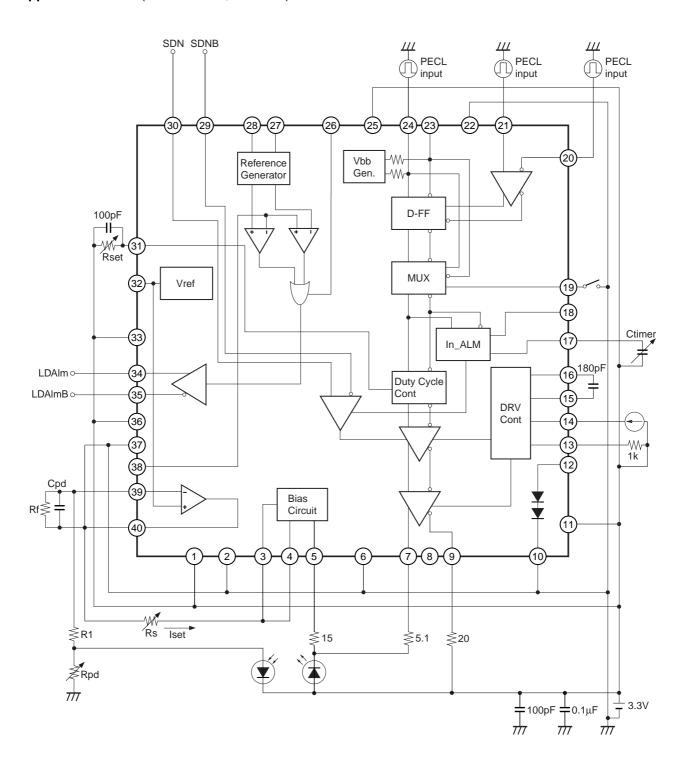
DC Electrical Characteristics Measurement Circuit



AC Electrical Characteristics Measurement Circuit



Application Circuit (at Vcc = 3.3V, VEE = 0V)



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Example of Representative Characteristics

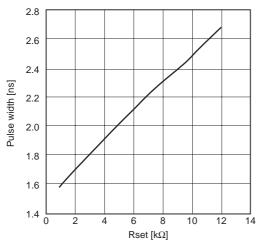


Fig. 1. Pulse width vs. Rset characteristics when 1.6ns input data pulse (622Mbps) is applied

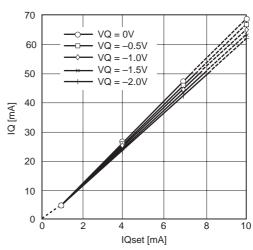


Fig. 2. Modulation current (Iq) vs. IQset characteristics

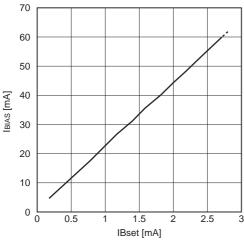


Fig. 3. Bias current (IBIAS) vs.
Bias adjust current (IBset) characteristics

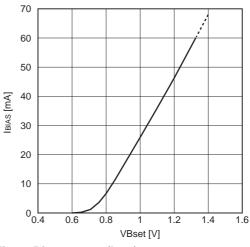


Fig. 4. Bias current (IBIAS) vs.
Bias adjust voltage (VBset) characteristics

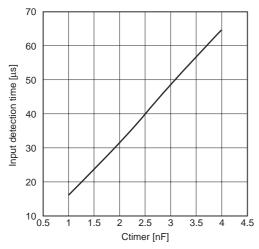


Fig. 6. Input detection time vs. Ctimer characteristics

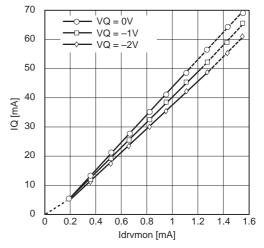
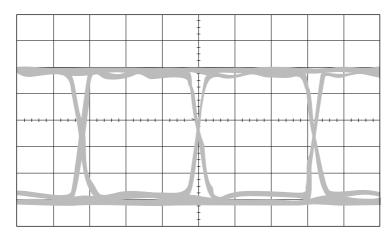


Fig. 7. Modulation current (IQ) vs.

DrvMon current characteristics

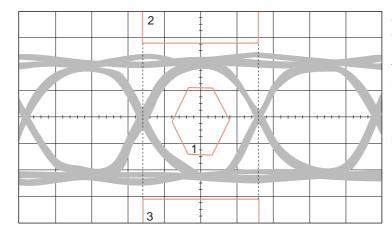
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VCC = 0V VEE = -3.3V RL = 25Ω Ta = 27° C IQ = 30mA Single-phase input Pattern = PRBS2²³ – 1 Data Rate 622Mbps

Ch.1: 150mV/div Time Base: 500ps/div

Fig. 8. Electrical Output Waveform



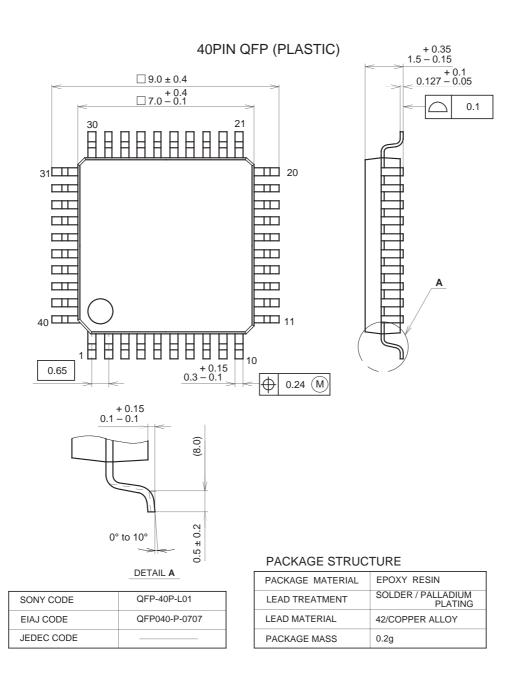
Vcc = 0V VEE = -3.3V FP – LD (λ = 1330nm) Ta = 27°C Single-phase input Pattern = PRBS2²³ – 1 Data Rate 622Mbps Filter (Cut Off 450MHz) Mask: STM4/OC12

Ch.2: 5.0mV/div Time Base: 500ps/div

Fig. 9. Optical Power Output Waveform

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Package Outline Unit: mm



NOTE: PALLADIUM PLATING

This product uses S-PdPPF (Sony Spec.-Palladium Pre-Plated Lead Frame).